

## ET2010

### End Termination

#### Description

ET2010 is a dippable, polymer-based silver conductor formulated as a post termination layer. The flexible termination can be applied over previously terminated multilayer ceramic chip capacitors. ET2010 can also function in chip resistor and chip fuse applications where cost and reliability are a concern. This termination is Pb and Cd free, Ni/Sn plateable, and provides excellent flexibility for rigorous industry bend test standards.

#### Typical Properties

Viscosity	23-33 Kcps Brookfield HBTSC4-14 spindle, 6R utility cup at 10 rpm, 25 C
Metal	Ag

#### Key Features

- Ni and Sn plateable
- Solvent resistant
- Room temperature stable
- Low Ag content
- Bend test flexibility  $\geq 10\text{mm}$



*This picture does not show the packaging of ET2010 and is solely intended for illustration purposes. The products are available in different packaging configurations and may change over time. Please refer to the latest safety data sheets for safety-relevant pictograms.*

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